



| SOD128 | Voltage Current<br>600 V 2.0 A  |  |
|--------|---|--|
|        | FEATURES  • Low profile package • Ideal for automated placement • Low power losses, high efficiency • High surge current capability • Cavity-free glass passivated junction • Low forward voltaje drop • Solder dip 260 °C, 10s • AEC-Q101 qualified • Component in accordance to RoHS 2011/65/EU and WEEE 2002/96/EC • Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C • Very soft recovery characteristics • Significantly reduced EMI. Very low Noise. |  |
|        | <ul> <li>MECHANICAL DATA</li> <li>Case: SOD128. Epoxy meets UL 94V-0 flammability rating.</li> <li>Polarity: Color band denotes cathode end.</li> <li>Terminals: Matte tin plated leads, solderable per MIL-STD-750 Method 2026, J-STD-002 and JESD22-B102. Consumer grade, meets JESD 201 class 1A whisker test.</li> <li>HE3 suffix for high reliability grade, meets JESD 201 class 2 whisker test.</li> </ul>   |  |
|        | TYPICAL APPLICATIONS  Used in high frecuency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.  |  |

# Maximum Ratings and Electrical Characteristics at 25 °C

|                        |   | FES2JZSR                     |  |
|------------------------|---|------------------------------|--|
|                        | Marking Code  | KA                           |  |
| V <sub>RRM</sub>       | Maximum Recurrent Peak Reverse Voltage (V)          | 600                          |  |
| V <sub>RMS</sub>       | Maximum RMS Voltage (V)                             | 420                          |  |
| V <sub>DC</sub>        | Maximum DC Blocking Voltage (V)                     | 600                          |  |
| I <sub>F (AV)</sub>    | Forward current at T <sub>L</sub> = 145 °C          | 2,0 A                        |  |
| C <sub>i</sub>         | Typical Junction Capacitance (1MHz; -4V)            | 25 pF                        |  |
| R <sub>th (j-a)</sub>  | Maximum Thermal Resistance Junction to Ambient:     |                              |  |
|                        | . FR4 PCB Standard Footprint                        | 162 ºC/W                     |  |
|                        | . FR4 PCBMounting Pad for Cathode 1cm <sup>2</sup>  | 112 ºC/W                     |  |
| R <sub>th (j-sp)</sub> | Maximum Thermal Resistance Junction to Solder Point | 15 °C/W                      |  |
| <b>-</b> -             | Operating Juction and Storage                       | - 65 to + 175 <sup>o</sup> C |  |
| j - I stg              | Temperature Range                                   | - 00 to + 1/5 -C             |  |

| Symbol           | Parameter  | Value | Units |
|------------------|--|-------|-------|
| I <sub>FSM</sub> | Non Repetitive surge peak forward current (8.3 msg. peak forward surge JEDEC Method) | 100A  | Amps. |



### **Static Electrical Characteristics**

| Symbol   | Parameter   | Test Conditions         |                        | Max. | Unit |
|--|---|-------------------------|------------------------|------|------|
|  |   | T <sub>j</sub> = 25 °C  | I <sub>F</sub> = 2.0 A | 1.70 |      |
| V <sub>F</sub>                                 | V <sub>F</sub> Max. Instantaneous Forward Voltage | T <sub>j</sub> = 100 ºC | I <sub>F</sub> = 2.0 A | 1.40 | V    |
|  |   | T <sub>j</sub> = 25 °C  | I <sub>F</sub> = 0.7 A | 1.40 |      |
| I <sub>R</sub> Max. DC Reverse Leakage Current | T <sub>j</sub> = 25 <sup>o</sup> C                | $V_R = V_{RRM}$         | 1                      |      |      |
|  | Max. DC Reverse Leakage Current                   | T <sub>j</sub> = 100 ºC | $V_R = V_{RRM}$        | 10   | μΑ   |
|  |   | T <sub>j</sub> = 150 ºC | $V_R = V_{RRM}$        | 100  |      |

## Recovery Characteristics (Tj = 25 °C)

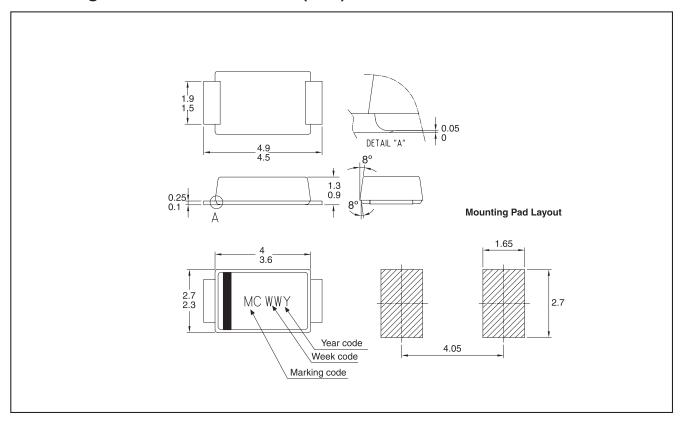
| Symbol | Test Conditions   | Max. | Тур. | Unit |
|--------|---|------|------|------|
| trr    | I <sub>F</sub> = 0.5A, I <sub>R</sub> = 1A, I <sub>rr</sub> = 0.25A | 25   |      | ns   |
| trr    |   | 40   | 30   |      |
| ta     | $I_F = 1A$ , $dI_F/dt = 50A/\mu$ , $V_R = 30V$                      |      | 17   | ns   |
| tb     |   |      | 13   |      |



# **Ordering information**

| PREFERRED P/N     | PACKAGE CODE | DELIVERY MODE              | BASE QUANTITY | UNIT WEIGHT (g) |
|-------------------|--------------|----------------------------|---------------|-----------------|
| FES2JZSR HE3 TRTB | TRTB         | 13" diameter tape and reel | 10,000        | 0.0180          |

# Package Outline Dimensions: (mm) SOD128





# **Ratings and Characteristics** ( $T_{amb} = 25^{\circ}C$ unless otherwise noted)

Fig. 1 RELATIVE VARIATION OF THERMAL IMPEDANCE TO AMBIENT vs. PULSE DURATION

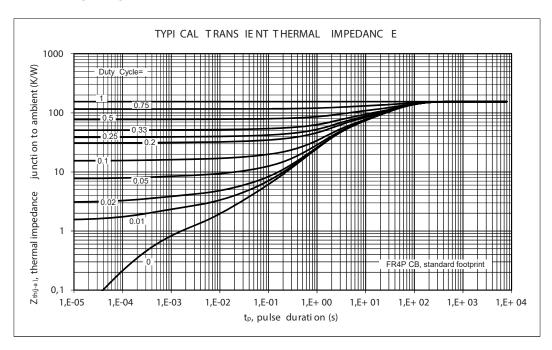
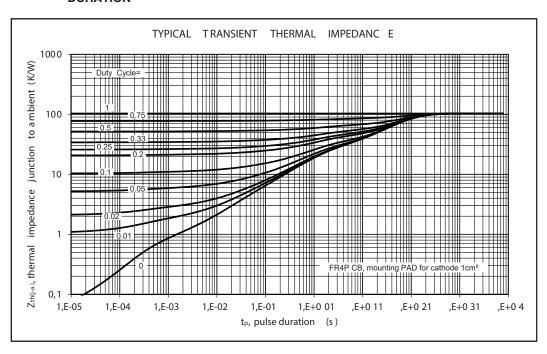


Fig. 2 RELATIVE VARIATION OF THERMAL IMPEDANCE TO AMBIENT vs. PULSE DURATION





**Ratings and Characteristics** ( $T_{amb} = 25^{\circ}C$  unless otherwise noted)

Fig. 3 TYPICAL JUNCTION CAPACITANCE vs. REVERSE VOLTAGE

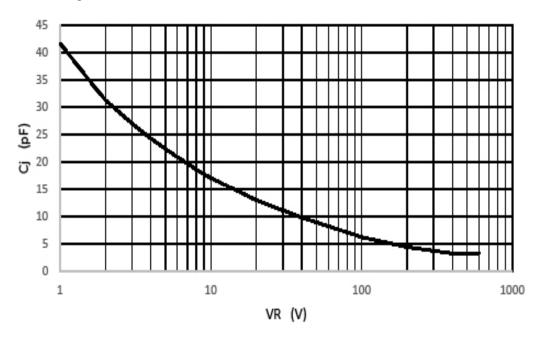
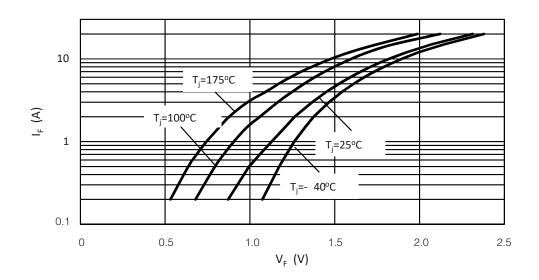


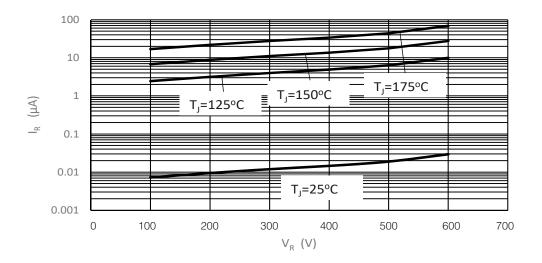
Fig. 4 TYPICAL FORWARD I-V CHARACTERISTICS AS A FUNCTION OF JUNCTION TEMPERATURE





**Ratings and Characteristics** ( $T_{amb} = 25^{\circ}C$  unless otherwise noted)

Fig. 5 TYPICAL REVERSE CURRENT vs. REVERSE VOLTAGE FOR DIFFERENT JUNCTION TEMPERATURES







#### **Revision History**

| DATE        | REVISION | DESCRIPTION OF CHANGES |
|-------------|----------|------------------------|
| 12-Jun-2018 | 0        | Original Data Sheet    |

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